

DESCRIPTION

SP687 blocks current flow in the X2 capacitor safety discharge resistors, reducing the power loss to less than 5mW at 230 VAC. When AC voltage is disconnected, SP687 automatically discharges the X2 capacitor by connecting the series discharge resistors. This operation allows total flexibility in the choice of the X2 capacitor to optimize differential mode EMI filtering and reduce inductor costs, with no change in power consumption. SP687 meets IEC 62368-1: 2018 version.

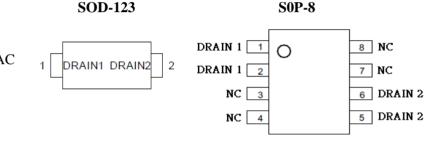
APPLICATIONS

- AC/DC Switching Power Adaptor/Desktop
- Battery Charger
- Open-Frame Switching Power Supply
- LED Power Supply

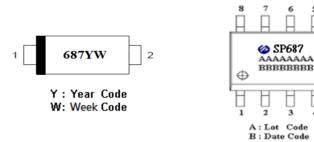
PIN CONFIGURATION

FEATURES

- 750V CDMOS Process
- Auto Re-Start
- X2 Capacitor Discharge
- Less than 5mW power consumption at 230VAC
- SOP-8/SOD-123 Package design

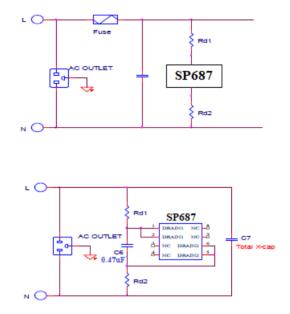


PART MARKING





TYPICALAPPLCATION CIRCUIT



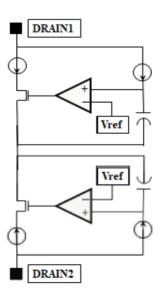
ORDERINGINFORMATION

Part Number	Package	Part Marking
SP687D12RGB	SOD123	687
SP687S8RGB	SOP-8	SP687

* SP687D12RGB : Tape Reel ; Pb – Free ; Halogen-Free

* SP687S8RGB : Tape Reel ; Pb – Free ; Halogen-Free

BLOCK DIAGRAM





ABSOULTE MAXIMUM RATINGS ($T_A=25^{\circ}C$, unless otherwise specified.)

The following ratings designate persistent limits beyond which damage to the device may occur.

PARAMETER		Symbol	RATINGS	Unit	
Turn on ID Max. Current Continues		I _D	7.5	mA	
Package Power Dissipation @ $TA \le 25^{\circ}C$ (SOP8)		P _D	0.85	W	
Package Power Dissipation @ $TA \le 25^{\circ}C$ (SOD123)		P _D	0.5	W	
Drain1 to Drain2 Voltage		V _{DSS}	750	v	
Operating Ambient Temperature	SOP-8	T _{OA}	85	°C	
Storage Temperature	SOP-8	T _{STG}	-65~+150	°C	
Operating Junction Temperature	SOP-8	TJ	-40~+125	°C	
Junction to Ambient *	SOP-8	θ_{JA}	147		
Case Temperature	501-0	θ_{JC}	28	°C/W	
Operating Ambient Temperature	SOD123	T _{OA}	85	°C	
Storage Temperature	SOD123	T _{STG}	-55~+150	°C	
Operating Junction Temperature	SOD123	Тյ	-40~+125	°C	
Junction to Ambient *	500122	θ_{JA}	250	°C/W	
Case Temperature	SOD123	θ_{JC}	50		

(*) The power dissipation and thermal resistance are evaluated under copper board mounted with free air conditions.



ELECTRICAL CHARACTERISTICS

$(T_A = 25^{\circ}C, V_{HV} = 30V, unless otherwise specified.)$									
PARAMETER	SYMBOL	TEST CONDITIONS	Min	Тур	Max	Unit			
Breakdown Voltage									
Drain1(d1) to Drain2 (d2)	BV _{DSS}		700			V			
Internal MOSFET Turn On Delay Time	e								
700V MOSFET On delay time	Ton delay	Vd1d2=50V, Rd1+Rd2=10.2K		200	400	mS			
700V MOSFET On delay time	Ton delay	Vd1d2=127V, Rd1+Rd2=10.2K		70	140	mS			
700V MOSFET Discharge Current									
700V MOSFET Discharge Current	I _D	Vd1d2=50V, Rd1+Rd2=10.2K		3.8		mA			
Discharge Time Test (400V discharged t	to 60V)								
400V to 60V discharging time test	Tdischarging	Rd1&Rd2=10.2K; Cx=0.47uF		45		mS			
Supply Current Without Turning on Internal MOSFET									
Supply Current @ line Frequency=47Hz	I supply ac	Vin=230 Vac and Frequency=47Hz			20	uA			



Information provided is alleged to be exact and consistent. SYNC Power Corporation presumes no responsibility for the penalties of use of such information or for any violation of patents or other rights of third parties that may result from its use. No license is granted by allegation or otherwise under any patent or patent rights of SYNC Power Corporation. Conditions mentioned in this publication are subject to change without notice. This publication surpasses and replaces all information previously supplied. SYNC Power Corporation products are not authorized for use as critical components in life support devices or systems without express written approval of SYNC Power Corporation.

 The SYNC Power logo is a registered trademark of SYNC Power Corporation
2020 SYNC Power Corporation – Printed in Taiwan – All Rights Reserved SYNC Power Corporation 7F-2, No.3-1, Park Street
NanKang District (NKSP), Taipei, Taiwan, 115, R.O.C Phone: 886-2-2655-8178 Fax: 886-2-2655-8468 http://www.syncpower.com

